

SECTION 27 05 26 - GROUNDING AND BONDING FOR COMMUNICATIONS SYSTEMS

PART 1 - GENERAL

1.1 SUMMARY

A. Section Includes:

1. Grounding conductors.
2. Grounding connectors.
3. Grounding busbars.
4. Grounding rods.
5. Grounding labeling.

1.2 DEFINITIONS

- A. BCT (BC): Bonding conductor for telecommunications.
- B. TBB: Telecommunications bonding backbone
- C. TGB: Telecommunications grounding busbar.
- D. TMGB: Telecommunications main grounding busbar.
- E. Service Provider: The operator of a service that provides telecommunications transmission delivered over access provider facilities.

1.3 SUBMITTALS

- A. Product Data: For each type of product.
- B. Shop Drawings: For communications equipment room signal reference grid. Include plans, elevations, sections, details, and attachments to other work.
- C. As-Built Data: Plans showing as-built locations of grounding and bonding infrastructure, including the following:
1. Ground rods.
 2. Ground and roof rings.
 3. BCT, TBB, TMGB, TGBs, and routing of their bonding conductors.
- D. Qualification Data: For installation supervisor and testing agency's field supervisor.
- E. At the completion of the project provide:
1. Result of the ground-resistance test, measured at the point of BCT connection.
 2. Result of the bonding-resistance test at each TGB and its nearest grounding electrode.

1.4 QUALITY ASSURANCE

- A. Installer Qualifications: Cabling Installer must have personnel certified by BICSI on staff.
 - 1. Installation Supervision: Installation shall be under the direct supervision of ITS Technician or have a RCDD certificate, who shall be present at all times when Work of this Section is performed at Project site.
 - 2. Field Inspector: Currently registered by BICSI as a designer RCDD or Technician to perform the on-site inspection.

PART 2 - PRODUCTS

2.1 SYSTEM DESCRIPTION

- A. Electrical Components, Devices, and Accessories: Listed and labeled as defined in NFPA 70, by a qualified testing agency, and marked for intended location and application.
- B. Comply with UL 467 for grounding and bonding materials and equipment.
- C. Comply with TIA-607-B.

2.2 CONDUCTORS

- A. Comply with UL 486A-486B.
- B. Insulated Conductors: Stranded copper wire, green or green with yellow stripe insulation, insulated for 600 V, and complying with UL 83.
 - 1. Ground wire for custom-length equipment ground jumpers shall be minimum No. 6 AWG, 19-strand, UL-listed, Type THHN wire.
 - 2. Cable Tray Equipment Grounding Wire: No. 6 AWG or larger.
- C. Cable Tray Grounding Jumper:
 - 1. Not smaller than No. 6 AWG and not longer than 12 inches. If jumper is a wire, it shall have a crimped grounding lug with two holes and long barrel for two crimps. If jumper is a flexible braid, it shall have a one-hole ferrule. Attach with grounding screw or connector provided by cable tray manufacturer.
- D. Bare Copper Conductors:
 - 1. Solid Conductors: ASTM B3.
 - 2. Stranded Conductors: ASTM B8.
 - 3. Tinned Conductors: ASTM B33.
 - 4. Bonding Cable (between closets): No 4/0 AWG, stranded conductor.
 - 5. Bonding Conductor (from TGB and TMGB to metal parts): No. 6 AWG, stranded conductor.
 - 6. Bonding Jumper: Tinned-copper tape, braided conductors terminated with two-hole copper ferrules; 1-5/8 inches wide and 1/16 inch thick.

2.3 CONNECTORS

- A. Irreversible connectors listed for the purpose. Listed by an NRTL as complying with NFPA 70 for specific types, sizes, and combinations of conductors and other items connected. Comply with UL 486A-486B.
- B. Compression Wire Connectors: Crimp-and-compress connectors that bond to the conductor when the connector is compressed around the conductor. Comply with UL 467.
 - 1. Electroplated tinned copper, C and H shaped.
- C. Signal Reference Grid Connectors: Combination of compression wire connectors, access floor grounding clamps, bronze U-bolt grounding clamps, and copper split-bolt connectors, designed for the purpose.
- D. Busbar Connectors: Cast silicon bronze, solderless compression or exothermic-type, mechanical connector; with a long barrel and two holes spaced on 5/8- or 1-inch centers for a two-bolt connection to the busbar.
- E. Welded Connectors: Exothermic-welding kits of types recommended by kit manufacturer for materials being joined and installation conditions.

2.4 GROUNDING BUSBARS

- A. TMGB: Predrilled, wall-mounted, rectangular bars of hard-drawn solid copper, 1/4 by 4 by 12 inches. The busbar shall be NRTL listed for use as TMGB and shall comply with TIA-607-B.
 - 1. Predrilling shall be with holes for use with lugs specified in this Section.
 - 2. Mounting Hardware: Stand-off brackets that provide a 4-inch clearance to access the rear of the busbar. Brackets and bolts shall be stainless steel.
 - 3. Stand-off insulators for mounting shall be Lexan or PVC. Comply with UL 891 for use in 600-V switchboards, impulse tested at 5000 V.
- B. TGB: Predrilled rectangular bars of hard-drawn solid copper, 1/4 by 4 by 12 inches. The busbar shall be for wall mounting, shall be NRTL listed as complying with UL 467, and shall comply with TIA-607-B.
 - 1. Predrilling shall be with holes for use with lugs specified in this Section.
 - 2. Mounting Hardware: Stand-off brackets that provide at least a 4-inch clearance to access the rear of the busbar. Brackets and bolts shall be stainless steel.
 - 3. Stand-off insulators for mounting shall be Lexan or PVC. Comply with UL 891 for use in 600-V switchboards, impulse tested at 5000 V.
- C. Rack and Cabinet Grounding Busbars (where grounding busbars are not provided with the rack or cabinet): Rectangular bars of hard-drawn solid copper, accepting conductors ranging from No. 14 to No. 2/0 AWG, NRTL listed as complying with UL 467, and complying with TIA-607-B. Predrilling shall be with holes for use with lugs specified in this Section.
 - 1. Cabinet-Mounted Busbar: Terminal block, with stainless-steel or copper-plated hardware for attachment to the cabinet.
 - 2. Rack-Mounted Horizontal Busbar: Designed for mounting in 19- or 23-inch equipment racks. Include a copper splice bar for transitioning to an adjoining rack, and stainless-steel or copper-plated hardware for attachment to the rack.
 - 3. Rack-Mounted Vertical Busbar: 72 or 36 inches long (or as required for rack height), with stainless-steel or copper-plated hardware for attachment to the rack.

PART 3 - EXECUTION

3.1 EXAMINATION

- A. Examine the ac grounding electrode system and equipment grounding for compliance with requirements for maximum ground-resistance level and other conditions affecting performance of grounding and bonding of the electrical system.
- B. Inspect the test results of the ac grounding system measured at the point of BCT connection.
- C. Proceed with connection of the BCT only after unsatisfactory conditions have been corrected.

3.2 INSTALLATION

- A. Bonding shall include the ac utility power service entrance, the communications cable entrance, and the grounding electrode system. The bonding of these elements shall form a loop so that each element is connected to at least two others.
- B. Comply with NECA 1.
- C. Comply with TIA-607-B.

3.3 APPLICATION

- A. Provide the following conductor sizes, unless larger is noted elsewhere.
- B. Conductors: Install stranded conductors for No. 6 AWG and larger unless otherwise indicated.
 - 1. The bonding conductors between the TGB and structural steel of steel-frame buildings shall not be smaller than No. 6 AWG.
 - 2. The bonding conductors between the TMGB and structural steel of steel-frame buildings shall not be smaller than No. 6 AWG.
- C. Underground Grounding Conductors: Install bare tinned-copper conductor, No. 4/0 AWG minimum.
- D. Conductor Terminations and Connections:
 - 1. Pipe and Equipment Grounding Conductor Terminations: Bolted connectors.
 - 2. Underground Connections: Welded connectors except at test wells and as otherwise indicated.
 - 3. Connections to Ground Rods at Test Wells: Bolted connectors.
 - 4. Connections to Structural Steel: Welded connectors.
- E. Conductor Support:
 - 1. Secure grounding and bonding conductors at intervals of not less than 36 inches.
- F. Grounding and Bonding Conductors:
 - 1. Install in the straightest and shortest route between the origination and termination point, and no longer than required. The bend radius shall not be smaller than eight times the diameter of the conductor. No one bend may exceed 90 degrees.
 - 2. Install without splices.

GROUNDING AND BONDING FOR COMMUNICATIONS SYSTEMS

3. Support at not more than 36-inch intervals.
4. Install grounding and bonding conductors in minimum 1-inch PVC conduit until conduit enters a telecommunications room. The grounding and bonding conductor pathway through a plenum shall be in EMT. Conductors shall not be installed in EMT unless otherwise indicated.
 - a. If a grounding and bonding conductor is installed in ferrous metallic conduit, bond the conductor to the conduit using a grounding bushing and bond both ends of the conduit to a TGB.

3.4 GROUNDING ELECTRODE SYSTEM

- A. The BCT between the TMGB and the ac service equipment ground shall not be smaller than No. 4/0 AWG, unless noted otherwise on the drawings.

3.5 GROUNDING BUSBARS

- A. Indicate locations of grounding busbars on Drawings. Install busbars horizontally, on insulated spacers 4 inches minimum from wall, 12 inches above finished floor unless otherwise indicated.
- B. Where indicated on both sides of doorways, route bus up to top of door frame, across top of doorway, and down; connect to horizontal bus.

3.6 CONNECTIONS

- A. Bond metallic equipment in a telecommunications equipment room to the grounding busbar in that room, using equipment grounding conductors not smaller than No. 6 AWG.
- B. Stacking of conductors under a single bolt is not permitted when connecting to busbars.
- C. Assemble the wire connector to the conductor, complying with manufacturer's written instructions and as follows:
 1. Use crimping tool and the die specific to the connector.
 2. Pretwist the conductor.
 3. Apply an antioxidant compound to all bolted and compression connections.
- D. Primary Protector: Bond to the TMGB with insulated bonding conductor.
- E. Interconnections: Interconnect all TGBs with the TMGB with the telecommunications backbone conductor. If more than one TMGB is installed, interconnect TMGBs using the grounding equalizer conductor. The telecommunications backbone conductor and grounding equalizer conductor size shall not be less than No. 4/0 AWG unless otherwise indicated.
- F. Telecommunications Enclosures and Equipment Racks: Bond metallic components of enclosures to the telecommunications bonding and grounding system. Install vertically mounted rack grounding busbar unless the enclosure and rack are manufactured with the busbar. Bond the equipment grounding busbar to the TGB No. 2 AWG bonding conductors.
- G. Structural Steel: Where the structural steel of a steel frame building is readily accessible within the room or space, bond each TGB and TMGB to the vertical steel of the building frame.

GROUNDING AND BONDING FOR COMMUNICATIONS SYSTEMS

- H. Electrical Power Panelboards: Where an electrical panelboard for telecommunications equipment is located in the same room or space, bond each TGB to the ground bar of the panelboard.
- I. Shielded Cable (where specified): Bond the shield of shielded cable to the TGB in communications rooms and spaces. Comply with TIA-568-C.1 and TIA-568-C.2 when grounding shielded balanced twisted-pair cables.
- J. Rack- and Cabinet-Mounted Equipment: Bond powered equipment chassis to the cabinet or rack grounding bar. Power connection shall comply with NFPA 70; the equipment grounding conductor in the power cord of cord- and plug-connected equipment shall be considered as a supplement to bonding requirements in this Section.
- K. Access Floors: Bond all metal parts of access floors to the TGB.

3.7 IDENTIFICATION

- A. Labels shall be preprinted or computer-printed type.
 - 1. Label TMGB(s) with "fs-TMGB," where "fs" is the telecommunications space identifier for the space containing the TMGB.
 - 2. Label TGB(s) with "fs-TGB," where "fs" is the telecommunications space identifier for the space containing the TGB.
 - 3. Label the BCT and each telecommunications backbone conductor at its attachment point: "WARNING! TELECOMMUNICATIONS BONDING CONDUCTOR. DO NOT REMOVE OR DISCONNECT!"

3.8 FIELD QUALITY CONTROL

- A. Testing Agency: Engage a qualified testing agency to perform tests and inspections.
- B. Perform tests and inspections.
- C. Tests and Inspections:
 - 1. Inspect physical and mechanical condition. Verify tightness of accessible, bolted, electrical connections with a calibrated torque wrench according to manufacturer's written instructions.
 - 2. Test the bonding connections of the system using an ac earth ground-resistance tester, taking two-point bonding measurements in each telecommunications equipment room containing a TMGB and a TGB and using the process recommended by BICSI TDMM. Conduct tests with the facility in operation.
 - a. Measure the resistance between the busbar and the nearest available grounding electrode. The maximum acceptable value of this bonding resistance is 100 milliohms.
 - 3. Test for ground loop currents using a digital clamp-on ammeter, with a full-scale of not more than 10 A, displaying current in increments of 0.01 A at an accuracy of plus/minus 2.0 percent.
 - a. With the grounding infrastructure completed and the communications system electronics operating, measure the current in every conductor connected to the TMGB and in each TGB. Maximum acceptable ac current level is 1 A.
- D. Excessive Ground Resistance: If resistance to ground at the BCT exceeds 5 ohms, notify Architect promptly and include recommendations to reduce ground resistance.

GROUNDING AND BONDING FOR COMMUNICATIONS SYSTEMS

- E. Grounding system will be considered defective if it does not pass tests and inspections.
- F. Prepare test and inspection reports.

END OF SECTION 27 05 26